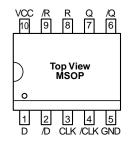
### **PACKAGE/ORDERING INFORMATION**



10-Pin MSOP (K10-1)

# Ordering Information<sup>(1)</sup>

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY55852UKC	K10-1	Commercial	55852U	Sn-Pb
SY55852UKCTR <sup>(2)</sup>	K10-1	Commercial	55852U	Sn-Pb
SY55852UKI	K10-1	Industrial	55852U	Sn-Pb
SY55852UKITR <sup>(2)</sup>	K10-1	Industrial	55852U	Sn-Pb
SY55852UKG <sup>(3)</sup>	K10-1	Industrial	55852U with Pb-Free bar line indicator	NiPdAu Pb-Free
SY55852UKGTR <sup>(2, 3)</sup>	K10-1	Industrial	55852U with Pb-Free bar line indicator	NiPdAu Pb-Free

#### Notes:

1. Contact factory for die availability. Dice are guaranteed at  $T_{\rm A}$  = 25°C, DC Electricals only.

2. Tape and Reel.

3. Pb-Free package recommended for new designs.

### **PIN DESCRIPTION**

Pin Number	Pin Name	Pin Function
1, 2	D, /D	CML/PECL/LVPECL Input (Differential): This is the single bit of data that gets clocked in and remembered.
3, 4	CLK, /CLK	CML/PECL/LVPECL Input (Differential): The rising edge of this signal is the clock signal that determines when the Boolean value at the data input gets stored.
5	GND	Ground.
6, 7	/Q, Q	CML Output (Differential): This is the output of the flip-flop.
8, 9	R, /R	CML/PECL/LVPECL Input (Differential): This is an asynchronous active high level reset, that forces the flip-flop into a known state, namely zero.
10	VCC	Power Supply.

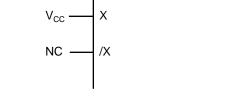
### TRUTH TABLE

D	CLK	R	Q	/Q
Х	Х	1	0	1
Х	0	0	Q <sub>N-1</sub>	/Q <sub>N-1</sub>
Х	1	0	Q <sub>N-1</sub> Q <sub>N-1</sub>	/Q <sub>N-1</sub> /Q <sub>N-1</sub>
0	Ŀ	0	0	1
1	Ŀ	0	1	0

### FUNCTIONAL DESCRIPTION

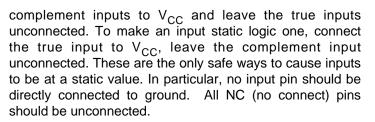
#### **Establishing Static Logic Inputs**

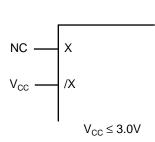
The true pin of an input pair is internally biased to ground through a 75k $\Omega$  resistor. The complement pin of an input pair is internally biased halfway between V<sub>CC</sub> and ground by a voltage divider consisting of two 75k $\Omega$  resistors. To keep an input at static logic zero at V<sub>CC</sub> > 3.0V, leave both inputs unconnected. For V<sub>CC</sub>  $\leq$  3.0V, connect the











V<sub>CC</sub> > 3.0V

NC — X NC — /X

Figure 2. Hard Wiring a Logic "0" (1)

## Absolute Maximum Ratings<sup>(1)</sup>

Supply Voltage (V <sub>CC</sub> )	–0.5V to +6.0V
CML Output Voltage	$V_{CC}$ –1.0 to $V_{CC}$ +0.5
Lead Temperature (soldering, 20 s	sec.) 260°C
Storage Temperature (T <sub>S</sub> )	–65°C to +150°C

## Operating Ratings<sup>(2)</sup>

Supply Voltage (V <sub>IN</sub> )	–0.5 to V <sub>CC</sub> +0.5V
Ambient Temperature (T <sub>A</sub> )	–40°C to +85°C
Package Thermal Resistance	
MSOP (θ <sub>JA</sub> )	
Still-Air	113°C/W
500lpfm	

#### Notes:

1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.

### DC ELECTRICAL CHARACTERISTICS<sup>(1)</sup>

 $V_{CC}$  = +2.3V to +5.7V; GND = 0V;  $T_A$  = -40°C to +85°C; unless otherwise noted.

Symbol	Parameter	Condition	Min	Тур	Мах	Units
V <sub>CC</sub>	Power Supply Voltage		2.3		5.7	V
I <sub>CC</sub>	Power Supply Current				36	mA

Note:

1. The device is guaranteed to meet the DC specifications, shown in the table above, after thermal equilibrium has been established. The device is tested in a socket such that transverse airflow of ≥500lfpm is maintained.

### CML DC ELECTRICAL CHARACTERISTICS<sup>(1)</sup>

 $V_{CC}$  = +2.3V to +5.7V; GND = 0V;  $T_A$  = -40°C to +85°C; unless otherwise noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V <sub>ID</sub>	Differential Input Voltage		100			mV
V <sub>IH</sub>	Input HIGH Voltage	Note 2	1.6	—	V <sub>CC</sub>	V
V <sub>IL</sub>	Input LOW Voltage	Note 2	1.5	—	V <sub>CC</sub> – 0.1	V
V <sub>OH</sub>	Output HIGH Voltage	No Load	V <sub>CC</sub> - 0.020	V <sub>CC</sub> – 0.010	V <sub>CC</sub>	V
V <sub>OL</sub>	Output LOW Voltage	No Load	V <sub>CC</sub> – 0.97	V <sub>CC</sub> – 0.825	V <sub>CC</sub> – 0.660	V
V <sub>OS</sub>	Output Voltage Swing	No Load, Note 3 50 $\Omega$ Environment, Note 4 100 $\Omega$ Environment, Note 5	0.660	0.800 0.200 0.400	0.950	V V V
R <sub>DRIVE</sub>	Output Source Impedance		80	100	120	Ω

Notes:

1. Equilibrium temperature.

- 2. Inputs must be biased to logic LOW or HIGH when  $\mathrm{V}_{\mathrm{CC}}$  is less than 3.0V.
- 3. Actual voltage levels and differential swing will depend on customer termination scheme. Typically, a 400mV swing is available in the 100Ω environment and a 200mV swing in the 50 $\Omega$  environment. Refer to the "CML Termination" diagram for more details.
- 4. See Figure 3a and 3b.
- 5. See Figure 4.

# AC ELECTRICAL CHARACTERISTICS<sup>(1)</sup>

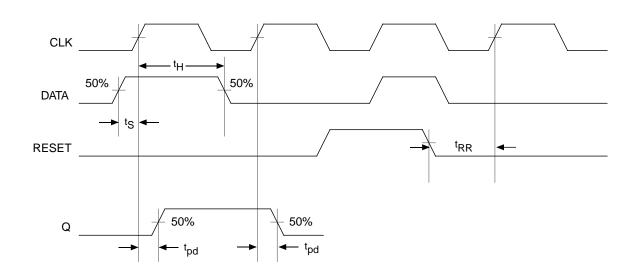
1/ 0.01/44		0V/. T 40	00 to .0000	
$V_{\rm CC} = 2.3 V$ to	5.7V; GND =	$0V; I_{\Delta} = -40$	°C to +85°C;	unless noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
f <sub>MAX</sub>	Max. Operating Frequency		2.5			GHz
t <sub>pd</sub>	Propagation Delay CLK to R to				400 500	ps
t <sub>S</sub>	Set-Up Time		40			ps
t <sub>H</sub>	Hold Time		40			ps
t <sub>RR</sub>	Reset Recovery		400			ps
t <sub>PW</sub>	Minimum Pulse Width CLK to R to	$V_{CC} \ge 3V$	160 140 250			ps
t <sub>r</sub> ,t <sub>f</sub>	CML Output Rise/Fall Times (20% to 80%)		35		150	ps

#### Note:

1. Tested using environment of Figure 3b, 50  $\Omega$  load CML output.

### TIMING DIAGRAMS



#### **CML TERMINATION**

All inputs accept the output from any other member of this family. All outputs are source terminated  $100\Omega$  CML differential drivers as shown in Figures 3 and 4. SY55852U expects the inputs to be terminated, and that good high

speed design practices be adhered to. SY55852U inputs are designed to accept a termination resistor between the true and complement inputs of a differential pair. 0402 form factor chip resistors will fit with some trace fanout.

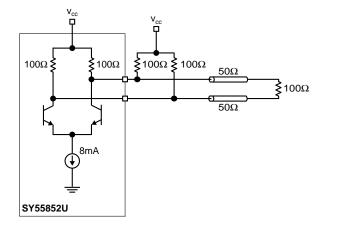


Figure 3a. Differentially Terminated (50Ω Load CML Output)

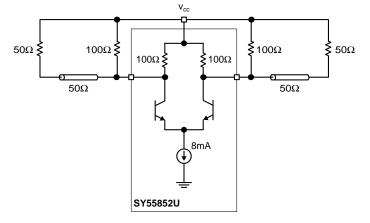


Figure 3b. Individually Terminated (50Ω Load CML Output)

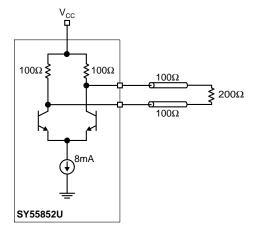
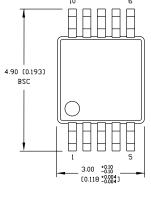
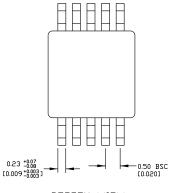


Figure 4. 100Ω Load CML Output

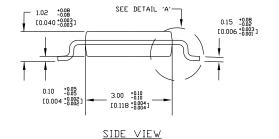
### 10-PIN MSOP (K10-1)

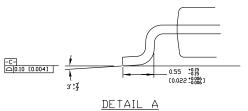




top view







NOTES

DIMENSIONS ARE IN MM [INCHES]. CONTROLLING DIMENSION: MM

- ż.
- DIMENSION DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS, EITHER OF WHICH SHALL NOT EXCEED 0.20 (0.008) PER SIDE

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